

Preliminary Data

SPP 47N10L

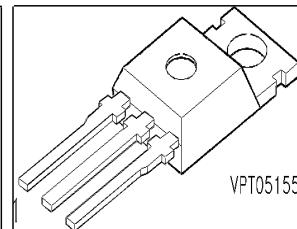
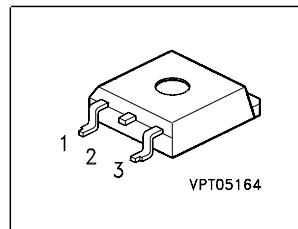
SIPMOS® Power Transistor

Features

- N channel
- Enhancement mode
- Avalanche rated
- Logic Level
- dv/dt rated
- 175 °C operating temperature

Product Summary

Drain source voltage	V_{DS}	100	V
Drain-Source on-state resistance	$R_{DS(on)}$	0.026	Ω
Continuous drain current	I_D	47	A



Type	Package	Ordering Code	Packaging	Pin 1	Pin 2	Pin 3
SPP47N10L	P-TO220-3-1	Q67040-S4177	Tube	G	D	S
SPB47N10L	P-TO263-3-2	Q67040-S4176	Tape and Reel			

Maximum Ratings, at $T_j = 25$ °C, unless otherwise specified

Parameter	Symbol	Value	Unit
Continuous drain current $T_C = 25$ °C	I_D	47	A
$T_C = 100$ °C		33	
Pulsed drain current $T_C = 25$ °C	I_{Dpulse}	188	
Avalanche energy, single pulse $I_D = 47$ A, $V_{DD} = 25$ V, $R_{GS} = 25$ Ω	E_{AS}	400	mJ
Avalanche energy, periodic limited by T_{jmax}	E_{AR}	17.5	
Reverse diode dv/dt $I_S = 47$ A, $V_{DS} = 0$ V, $di/dt = 200$ A/μs	dv/dt	6	kV/μs
Gate source voltage	V_{GS}	±20	V
Power dissipation $T_C = 25$ °C	P_{tot}	175	W
Operating and storage temperature	T_j, T_{stg}	-55... +175	°C
IEC climatic category; DIN IEC 68-1		55/175/56	

Thermal Characteristics

Parameter	Symbol	Values			Unit
		min.	typ.	max.	
Characteristics					
Thermal resistance, junction - case	R_{thJC}	-	-	0.85	K/W
Thermal resistance, junction - ambient	R_{thJA}	-	-	62	
SMD version, device on PCB: @ min. footprint @ 6 cm ² cooling area ¹⁾	R_{thJA}	-	-	62	
		-	-	40	

Electrical Characteristics, at $T_j = 25^\circ\text{C}$, unless otherwise specified

Parameter	Symbol	Values			Unit
		min.	typ.	max.	
Static Characteristics					
Drain- source breakdown voltage $V_{GS} = 0 \text{ V}$, $I_D = 0.25 \text{ mA}$	$V_{(BR)DSS}$	100	-	-	V
Gate threshold voltage, $V_{GS} = V_{DS}$ $I_D = 2 \text{ mA}$	$V_{GS(\text{th})}$	1.2	1.6	2	
Zero gate voltage drain current- $V_{DS} = 100 \text{ V}$, $V_{GS} = 0 \text{ V}$, $T_j = 25^\circ\text{C}$ $V_{DS} = 100 \text{ V}$, $V_{GS} = 0 \text{ V}$, $T_j = 150^\circ\text{C}$	I_{DSS}	-	0.1	1	μA
-		-	-	100	
Gate-source leakage current $V_{GS} = 20 \text{ V}$, $V_{DS} = 0 \text{ V}$	I_{GSS}	-	10	100	nA
Drain-Source on-state resistance $V_{GS} = 4.5 \text{ V}$, $I_D = 33 \text{ A}$ $V_{GS} = 10 \text{ V}$, $I_D = 33 \text{ A}$	$R_{DS(\text{on})}$	-	0.025	0.04	Ω
-		-	0.018	0.026	

¹ Device on 40mm*40mm*1.5mm epoxy PCB FR4 with 6 cm² (one layer, 70 μm thick) copper area for drain connection. PCB is vertical without blown air.

Electrical Characteristics, at $T_j = 25^\circ\text{C}$, unless otherwise specified

Parameter	Symbol	Values			Unit
		min.	typ.	max.	
Dynamic Characteristics					
Transconductance $V_{DS} \geq 2 * I_D * R_{DS(on)max}$, $I_D = 33 \text{ A}$	g_{fs}	18	36	-	S
Input capacitance $V_{GS} = 0 \text{ V}$, $V_{DS} = 25 \text{ V}$, $f = 1 \text{ MHz}$	C_{iss}	-	2000	2500	pF
Output capacitance $V_{GS} = 0 \text{ V}$, $V_{DS} = 25 \text{ V}$, $f = 1 \text{ MHz}$	C_{oss}	-	375	470	
Reverse transfer capacitance $V_{GS} = 0 \text{ V}$, $V_{DS} = 25 \text{ V}$, $f = 1 \text{ MHz}$	C_{rss}	-	210	265	
Turn-on delay time $V_{DD} = 50 \text{ V}$, $V_{GS} = 4.5 \text{ V}$, $I_D = 47 \text{ A}$, $R_G = 2 \Omega$	$t_{d(on)}$	-	50	75	ns
Rise time $V_{DD} = 50 \text{ V}$, $V_{GS} = 4.5 \text{ V}$, $I_D = 47 \text{ A}$, $R_G = 2 \Omega$	t_r	-	100	150	
Turn-off delay time $V_{DD} = 50 \text{ V}$, $V_{GS} = 4.5 \text{ V}$, $I_D = 47 \text{ A}$, $R_G = 2 \Omega$	$t_{d(off)}$	-	50	75	
Fall time $V_{DD} = 50 \text{ V}$, $V_{GS} = 4.5 \text{ V}$, $I_D = 47 \text{ A}$, $R_G = 2 \Omega$	t_f	-	70	105	

Electrical Characteristics, at $T_j = 25^\circ\text{C}$, unless otherwise specified

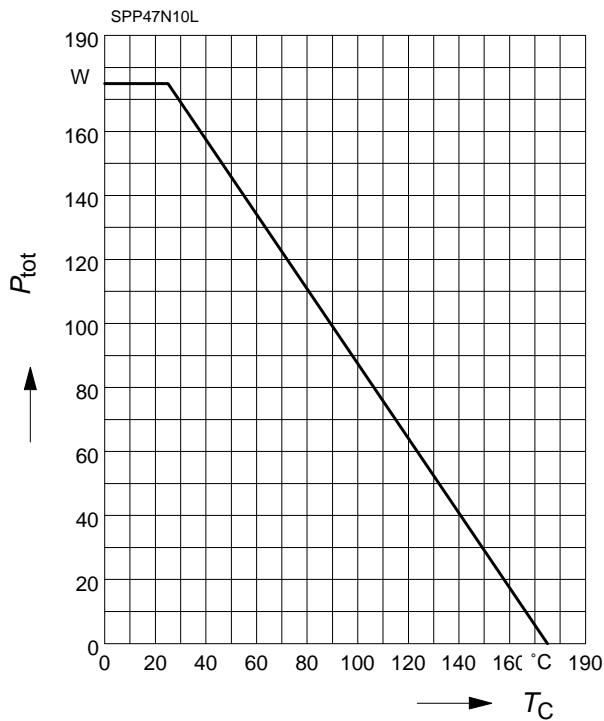
Parameter	Symbol	Values			Unit
		min.	typ.	max.	
Dynamic Characteristics					
Gate to source charge $V_{DD} = 80 \text{ V}, I_D = 47 \text{ A}$	Q_{gs}	-	8	12	nC
Gate to drain charge $V_{DD} = 80 \text{ V}, I_D = 47 \text{ A}$	Q_{gd}	-	16	24	
Gate charge total $V_{DD} = 80 \text{ V}, I_D = 47 \text{ A}, V_{GS} = 0 \text{ to } 10 \text{ V}$	Q_g	-	90	135	
Gate plateau voltage $V_{DD} = 80 \text{ V}, I_D = 47 \text{ A}$	$V_{(\text{plateau})}$	-	3.38	-	V

Reverse Diode

Inverse diode continuous forward current $T_C = 25^\circ\text{C}$	I_S	-	-	47	A
Inverse diode direct current,pulsed $T_C = 25^\circ\text{C}$	I_{SM}	-	-	188	
Inverse diode forward voltage $V_{GS} = 0 \text{ V}, I_F = 94 \text{ A}$	V_{SD}	-	1.1	1.5	V
Reverse recovery time $V_R = 50 \text{ V}, I_F=I_S, di_F/dt = 100 \text{ A}/\mu\text{s}$	t_{rr}	-	80	120	ns
Reverse recovery charge $V_R = 50 \text{ V}, I_F=I_S, di_F/dt = 100 \text{ A}/\mu\text{s}$	Q_{rr}	-	340	510	nC

Power Dissipation

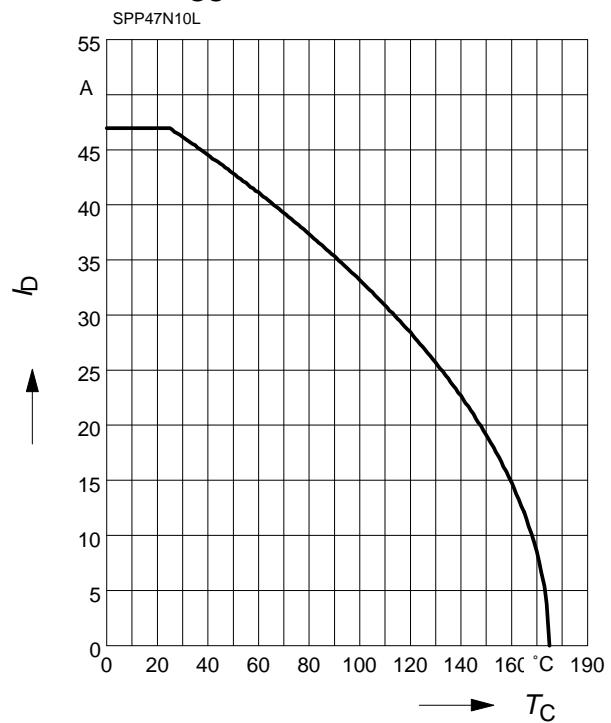
$$P_{\text{tot}} = f(T_C)$$



Drain current

$$I_D = f(T_C)$$

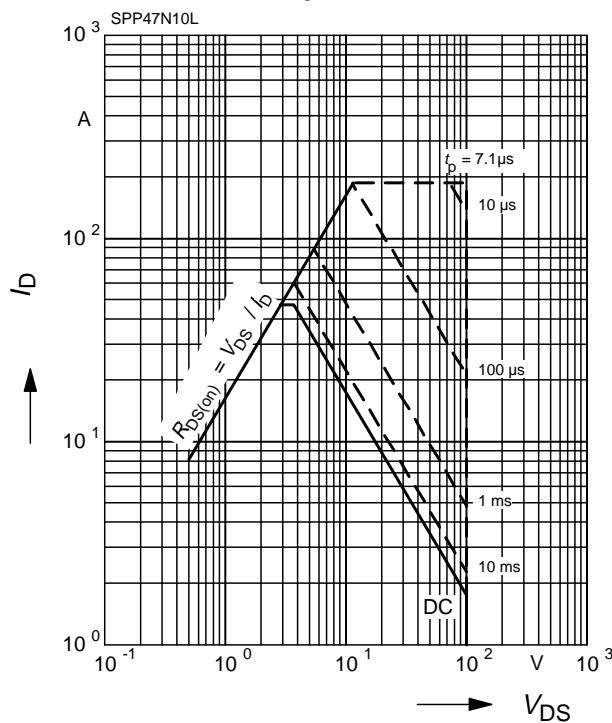
parameter: $V_{GS} \geq 10$ V



Safe operating area

$$I_D = f(V_{DS})$$

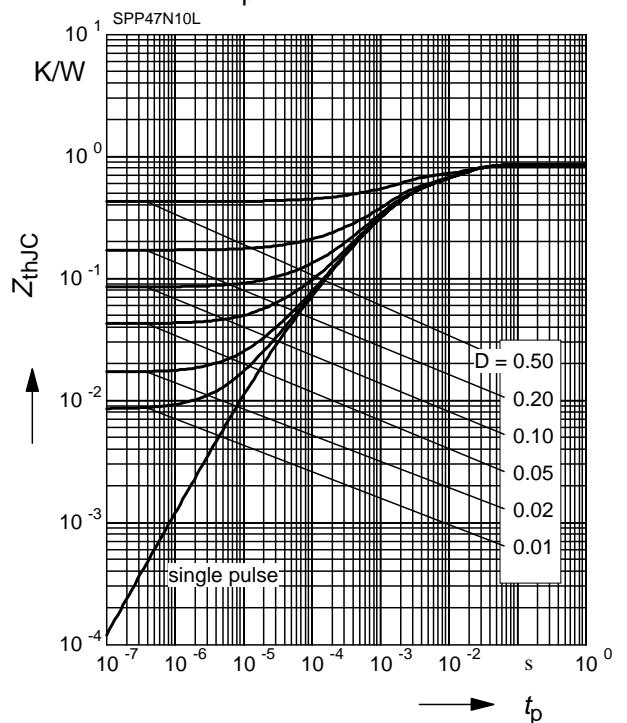
parameter : $D = 0$, $T_C = 25$ °C



Transient thermal impedance

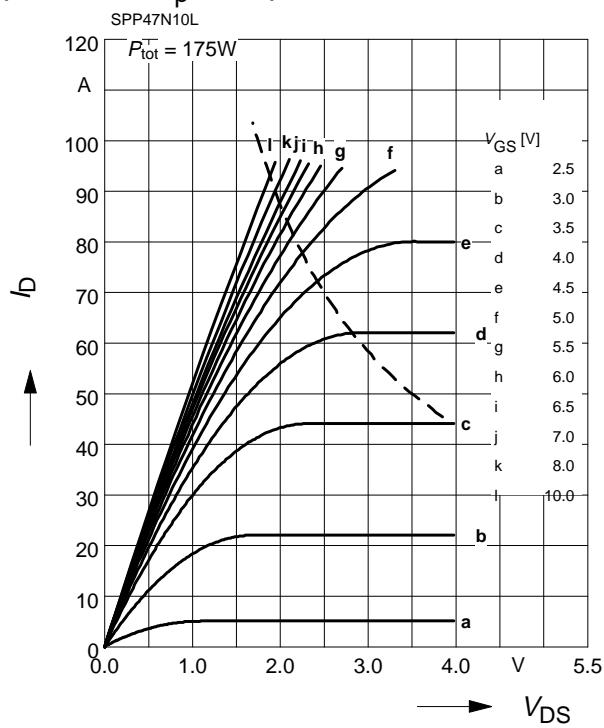
$$Z_{\text{thJC}} = f(t_p)$$

parameter : $D = t_p/T$



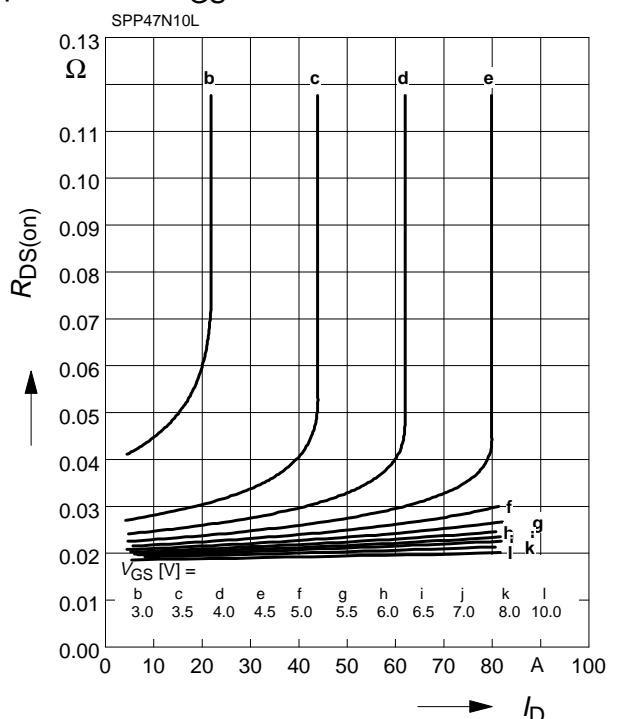
Typ. output characteristics $I_D = f(V_{DS})$

parameter: $t_p = 80 \mu s$



Typ. drain-source-on-resistance $R_{DS(on)} = f(I_D)$

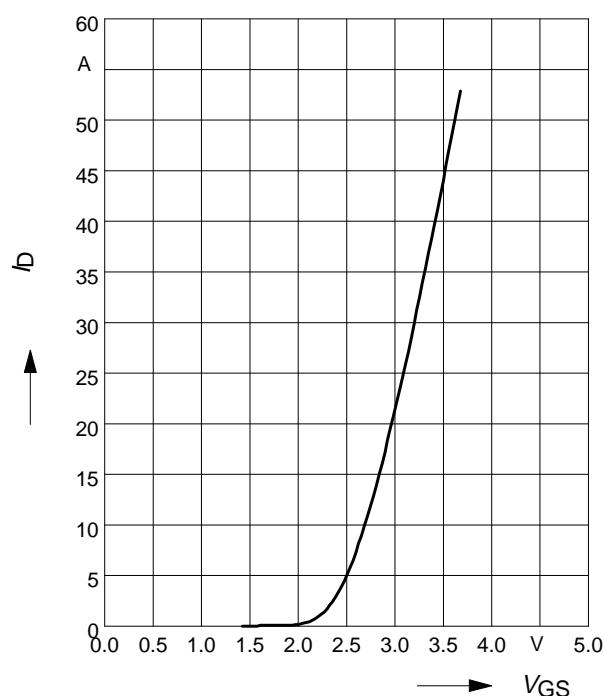
parameter: V_{GS}



Typ. transfer characteristics $I_D = f(V_{GS})$

parameter: $t_p = 80 \mu s$

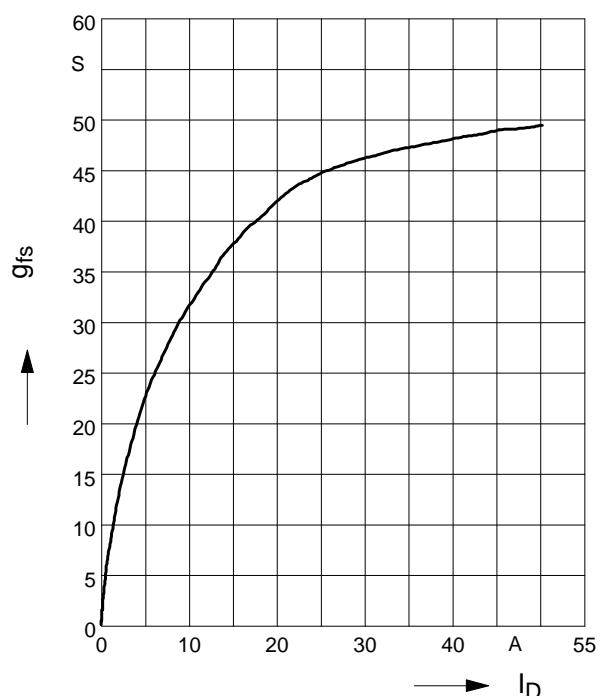
$V_{DS} \geq 2 \times I_D \times R_{DS(on)\max}$



Typ. forward transconductance $g_{fs} = f(I_D)$

$T_j = 25^\circ C$

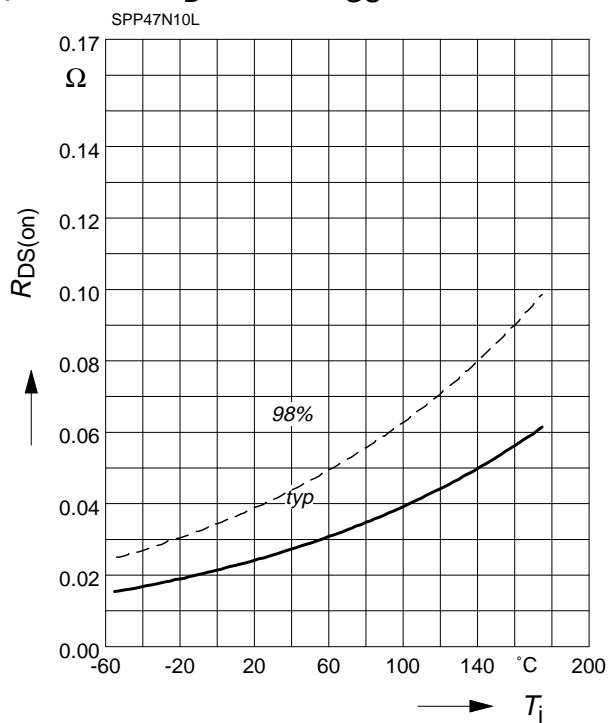
parameter: g_{fs}



Drain-source on-resistance

$$R_{DS(on)} = f(T_j)$$

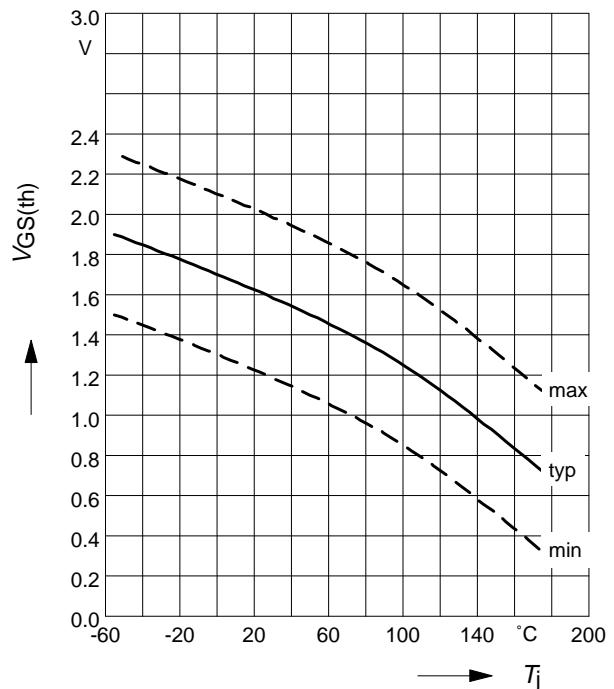
parameter : $I_D = 33 \text{ A}$, $V_{GS} = 4.5 \text{ V}$



Gate threshold voltage

$$V_{GS(th)} = f(T_j)$$

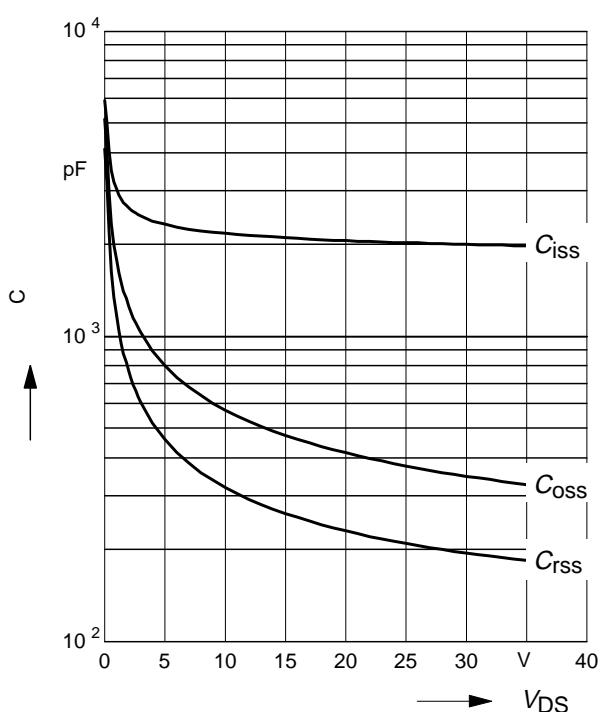
parameter : $V_{GS} = V_{DS}$, $I_D = 2 \text{ mA}$



Typ. capacitances

$$C = f(V_{DS})$$

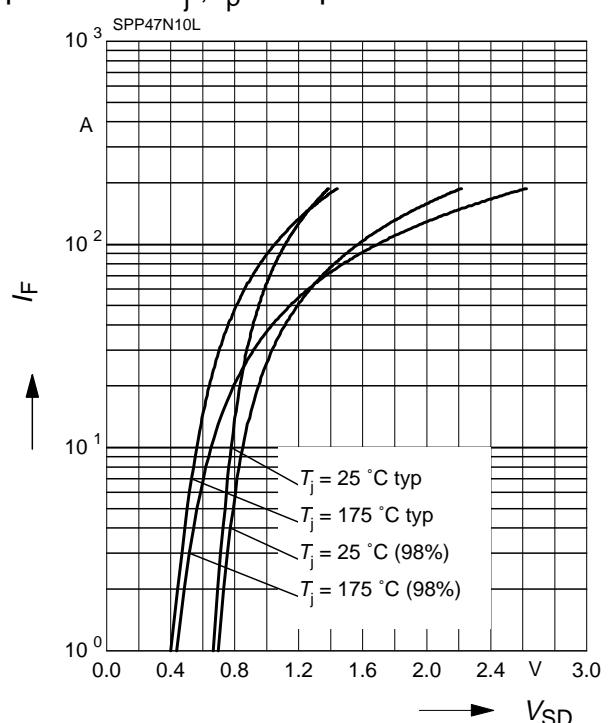
parameter: $V_{GS} = 0 \text{ V}$, $f = 1 \text{ MHz}$



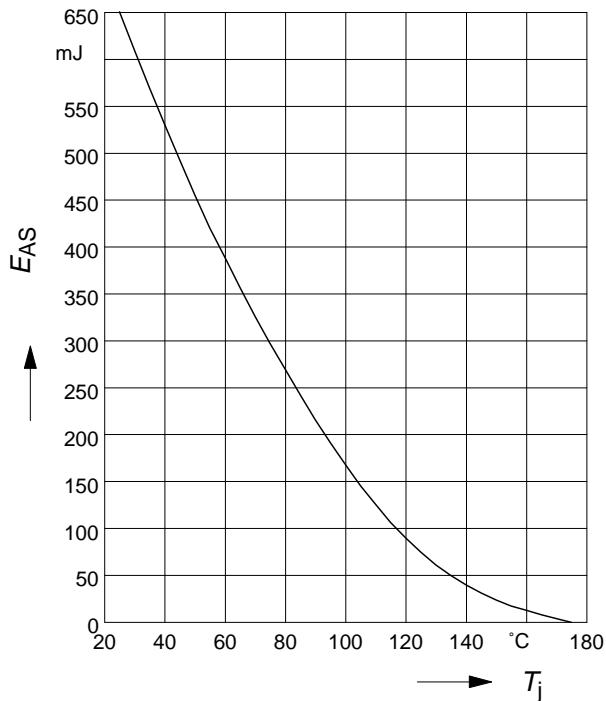
Forward characteristics of reverse diode

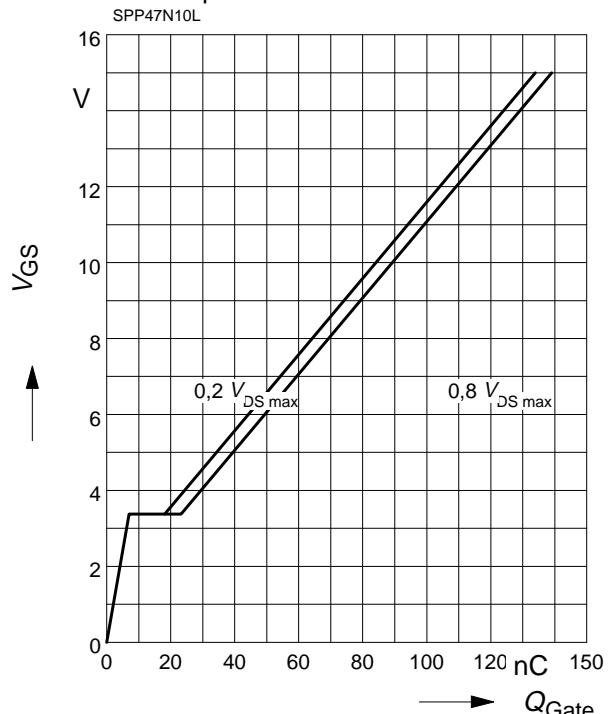
$$I_F = f(V_{SD})$$

parameter: T_j , $t_p = 80 \mu\text{s}$



Avalanche Energy $E_{AS} = f(T_j)$

 parameter: $I_D = 47 \text{ A}$, $V_{DD} = 25 \text{ V}$
 $R_{GS} = 25 \Omega$

Typ. gate charge
 $V_{GS} = f(Q_{Gate})$

 parameter: $I_D \text{ puls} = 47 \text{ A}$

Drain-source breakdown voltage
 $V_{(BR)DSS} = f(T_j)$
